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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/713,172	11/14/2003	Aaron Partridge	11403/84	9823	
26646 KENYON & F	7590 02/26/200 KENYON LLP	9	EXAM	UNER	
ONE BROAD	WAY		SMITH, FRANCIS P		
NEW YORK,	NY 10004		ART UNIT	PAPER NUMBER	
			1792		
			MAIL DATE	DELIVERY MODE	
			02/26/2009	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)					
Advisory Action	10/713,172	PARTRIDGE ET AL.					
Before the Filing of an Appeal Brief	Examiner	Art Unit					
	Francis P. Smith	1792					
The MAILING DATE of this communication appe	ears on the cover sheet with the c	correspondence add	ress				
HE REPLY FILED 17 February 2009 FAILS TO PLACE THIS	APPLICATION IN CONDITION FO	R ALLOWANCE.					
☑ The reply was filed after a final rejection, but prior to or on application, applicant must timely file one of the following application in condition for allowance; (2) a Notice of Applo for Continued Examination (RCE) in compliance with 37 c periods:  a) ☑ The period for reply expires 3 months from the mailing date  in the period for reply expires 3 months from the mailin	replies: (1) an amendment, affidavi eal (with appeal fee) in compliance CFR 1.114. The reply must be filed	t, or other evidence, v with 37 CFR 41.31; o	which places the r (3) a Request				
The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection.  Examiner Note: Ibox 1 is checked, check either box (a) or (b). ONLY CHECK BOX (b) WHEN THE FIRST REPLY WAS FILED WITHIN TWO MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).							
tensions of time may be obtained under 37 CFR 1.136(a). The date we been filled is the date for purposes of determining the period of ex der 37 CFR 1.17(a) is calculated from: (1) the expiration date of the storth in (b) above, if checked. Any reply received by the Office latery is reduce any earned patent term adjustment. See 37 CFR 1.704(b)	tension and the corresponding amount of shortened statutory period for reply origing than three months after the mailing dat	of the fee. The appropri- nally set in the final Office	ate extension fee te action; or (2) as				
OTICE OF APPEAL							
☐ The Notice of Appeal was filed on A brief in comp filing the Notice of Appeal (37 CFR 41.37(a)), or any exter Notice of Appeal has been filed, any reply must be filed w MENDMENTS	nsion thereof (37 CFR 41.37(e)), to	avoid dismissal of the					
The proposed amendment(s) filed after a final rejection,  (a) They raise new issues that would require further co  (b) They raise the issue of new matter (see NOTE belo	nsideration and/or search (see NOT w);	E below);					
<ul> <li>(c) They are not deemed to place the application in bet appeal; and/or</li> </ul>	ter form for appeal by materially rec	lucing or simplifying t	ne issues for				
(d) They present additional claims without canceling a		cted claims.					
NOTE: <u>See Continuation Sheet</u> (See 37 CFR 1.1							
The amendments are not in compliance with 37 CFR 1.13		mpliant Amendment (	PTOL-324).				
Applicant's reply has overcome the following rejection(s)							
Newly proposed or amended claim(s) would be all non-allowable claim(s).	lowable if submitted in a separate, t	imely filed amendmer	it canceling the				
For purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is proved the status of the claim(s) is (or will be) as follows:		be entered and an e	xplanation of				
Claim(s) allowed:							
Claim(s) objected to: Claim(s) rejected: 1-30 and 41-56.							
Claim(s) withdrawn from consideration:							
FIDAVIT OR OTHER EVIDENCE							

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> because applicant failed to provide a showing of good and sufficient reasons why the affidavit or other evidence is necessary and was not earlier presented. See 37 CFR 1.116(e).

9. The affidavit or other evidence filed after the date of filing a Notice of Appeal, but prior to the date of filing a brief, will not be entered because the affidavit or other evidence failed to overcome all rejections under appeal and/or appellant fails to provide a showing a good and sufficient reasons why it is necessary and was not earlier presented. See 37 CFR 41.33(d)(1).

10. The affidavit or other evidence is entered. An explanation of the status of the claims after entry is below or attached.

REQUEST FOR RECONSIDERATION/OTHER

11. The request for reconsideration has been considered but does NOT place the application in condition for allowance because: See Continuation Sheet.

12. Note the attached Information Disclosure Statement(s). (PTO/SB/08) Paper No(s).

13. Other:

/Michael Kornakov/

/Francis Smith/, Examiner

Supervisory Patent Examiner, Art Unit 1792

Continuation of 3. NOTE: Amendment to claims 1 and 41, if entered, changes the scope of the dependent claims, which would require at least additional consideration and possibly a new search.

Continuation of 11. does NOT place the application in condition for allowance because: Applicants argue the prior art reference to Yu does not "disclose or suggest forming a silicon dioxide layer which includes heating a substrate to anneal a sub-layer of the silicon oxide layer, where the temperature to which the substrate is heated for the annealing is approximate to a highest processing temperature applied subsequent to the forming of the silicon oxide layer". The examiner respectfully disagrees. In examples 1-5, Yu clearly teaches forming a silicon oxide layer at a first temperature (e.g. 920 C). Subsequently, Yu's examples 6-8 teach applying a post anneal step "having formed thereupon the gap filling silicon oxide layer" (col. 10, lines 56-66). Furthermore, it has been held that the selection of any order of performing process steps is prima facie obvious in the absence of new or unexpected results. It is also noted that the secondary reference to ito at least teaches forming a silicon oxide layer (e.g. at a first temperature), heating the substrate to a second temperature wherein the second temperature is approximate to the highest processing temperature subsequently applied to the substrate following the formation of the silicon oxide layer, and whereby the film is formed by an iterative process (see Ito; col. 3, line 64-col. 4, line 4, 49-65). Applicants also argue that the Yu/lto combination does not disclose nor suggest forming a silicon oxide layer with a compressive stress. However, it is noted that Yu/Ito teach substantially the same process steps as those recited in claim 11. As per Applicants' argument that Yu/Ito does not disclose or suggest "forming a silicon oxide layer with a compressive stress," it is axiomatic that one who performs the steps of a process must necessarily produce all of its advantages and the mere recitation of a newly discovered property that is inherently possessed by the steps in the prior art does not cause a claim drawn to those steps to distinguish over the prior art. Furthermore, independent claims 1 and 41 are currently amended, which changes the scope of at least the dependent claims; and there, additional considerations are deemed necessary.